

Features

- Equivalent High Pass P-N-P Transistor
- Current Limiting0.6A to 1.2A
- Over-Voltage Shutdown+25V to +40V
- Junction Temperature Thermal Limit.....+150°C
- Equivalent Beta of 25. 400mA/0.5V
- Internal Bandgap Voltage and Current Reference

Applications

- Fuel Pump Driver
- Relay Driver
- Solenoid Driver
- Stepper Motor Driver
- Remote Power Switch
- Logic Control Switch

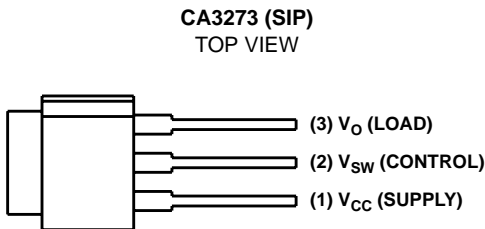
Description

The CA3273 is a power IC equivalent of a P-N-P pass transistor operated as a high-side-driver current switch in either the saturated (ON) or cutoff (OFF) modes. The CA3273 incorporates circuitry to protect the pass currents, excessive input voltage, and thermal overstress. The high-side driver is intended for general purpose, automotive and potentially high-stress applications. If high-stress conditions exist, the use of an external zener diode of 35V or less between supply and load terminals may be required to prevent damage due to severe conditions (such as load dump, reverse battery and positive or negative transients). The CA3273 is designed to withstand a nominal reverse-battery (VBAT = 13V) condition without permanent damage to the IC. The CA3273 is supplied in a modified 3-lead TO-202 plastic power package.

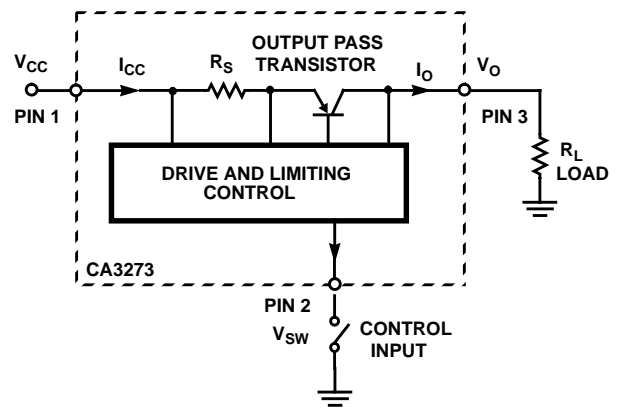
Ordering Information

| PART NUMBER | TEMPERATURE RANGE | PACKAGE |
|-------------|-------------------|---------------------|
| CA3273 | -40°C to +85°C | TO-202 Modified SIP |

Pinout



Block Diagram



Specifications CA3273

Absolute Maximum Ratings

| | |
|--|-----------------------|
| Fault Max, Supply Voltage, V_{CC} | 40V |
| Maximum Operating V_{CC} : | |
| At $I_O = 400\text{mA}$ (-40°C to +85°C Ambient) | 16V |
| At $I_O = 600\text{mA}$ (-40°C to +25°C Ambient) | 24V |
| Max. Positive Output Peak Pulse, V_{SW} Open | $V_{CC} + 12\text{V}$ |
| Max. Operating Output Load Current | 600mA |
| Short Circuit Load Current, I_{SC} | Internal Limiting |
| Reverse Battery | -13V |

Thermal Information

| | |
|--|-----------------|
| Thermal Resistance | θ_{JA} |
| Plastic SIP Package | +70°C/W |
| Maximum Power Dissipation, P_D | |
| At +25°C Ambient, T_A (Note 1) | 1.8W |
| Derate above +25°C (No Heat Sink) | 14.3mW/°C |
| Maximum Junction Temperature, T_J (Note 2) | 150°C |
| Ambient Operating Temperature Range | -40°C to +85°C |
| Storage Temperature Range | -40°C to +150°C |
| Lead Temperature (Soldering 10s max) | +265°C |

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Electrical Specifications $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$, Unless Otherwise Noted, See Block Diagram for Test Pin Reference

| PARAMETERS | SYMBOL | TEST CONDITIONS | MIN | TYP | MAX | UNITS |
|---|---------------|--|------|-----|------|---------------|
| Operating Voltage Range | V_{CC} | V_{CC} Reference to V_{SW} | 4 | - | 24 | V |
| Saturation Voltage ($V_{CC} - V_O$) | V_{SAT} | $I_O = -400\text{mA}$, $V_{SW} = 0\text{V}$, $V_{CC} = 16\text{V}$ | - | - | 0.5 | V |
| Operating Load | R_L | $V_{SW} = 0\text{V}$ (Switch ON) | | | | |
| | | $T_A = +85^\circ\text{C}$, $V_{CC} = 16\text{V}$ | 40 | - | - | Ω |
| | | $T_A = +25^\circ\text{C}$, $V_{CC} = 24\text{V}$ | 40 | | | Ω |
| Over-Voltage Shutdown Threshold | $V_{CC(THD)}$ | $V_{SW} = 0\text{V}$, $R_L = 1\text{k}\Omega$, Increase V_{CC} , (V_O goes low) | 25 | 33 | 40 | V |
| Over-Current Limiting | $I_{O(LIM)}$ | $V_{CC} = 16\text{V}$, $V_{SW} = 1\text{V}$ (Switch ON) | - | - | 1.2 | A |
| Over-Temperature Limiting | T_{LIM} | | - | 150 | - | °C |
| Control Current, Switch ON | I_{SW} | $V_{CC} = 16\text{V}$, $V_{SW} = 0\text{V}$ | | | | |
| | | $I_O = 0\text{mA}$ | - | -15 | - | mA |
| | | $I_O = -400\text{mA}$ | - | -22 | - | mA |
| Control Current, Max. Load, Switch ON | | $V_{CC} = 24\text{V}$, $V_{SW} = 0\text{V}$, $I_O = -600\text{mA}$ | - | -33 | - | mA |
| Max. Control Current, High and Low V_{CC} | $I_{SW(MAX)}$ | $R_L = 40\Omega$, $V_{SW} = 1\text{V}$ | | | | |
| | | $V_{CC} = 24\text{V}$ | -50 | - | - | mA |
| | | $V_{CC} = 7\text{V}$ | -50 | - | - | mA |
| Min. Control Current, No Load, Switch OFF | $I_{SW(NL)}$ | $V_O = \text{Open}$, (Switch OFF) | | | | |
| | | $V_{CC} = 24\text{V}$, $V_{SW} = 23\text{V}$ | -200 | - | +50 | μA |
| | | $V_{CC} = 7\text{V}$, $V_{SW} = 6\text{V}$ | -200 | - | +50 | μA |
| Output Current Leakage | $I_{O(LEAK)}$ | $V_O = 0\text{V}$, $V_{CC} = 16\text{V}$, (Switch OFF) | | | | |
| | | $V_{SW} = 16\text{V}$ | -100 | - | +100 | μA |
| | | $V_{SW} = 15\text{V}$ | -100 | - | +100 | μA |

NOTES:

- The calculation for dissipation and junction temperature rise due to dissipation is: $P_D = (V_{CC} - V_O) \times I_O + V_{CC} \times I_{SW}$ and $T_J = T_A + P_D \times \theta_{JA}$ where T_J is device junction temperature, T_A is ambient temperature and θ_{JA} is the junction-to-ambient thermal resistance.
- Thermal limiting occurs at +150°C on the chip.

CA3273

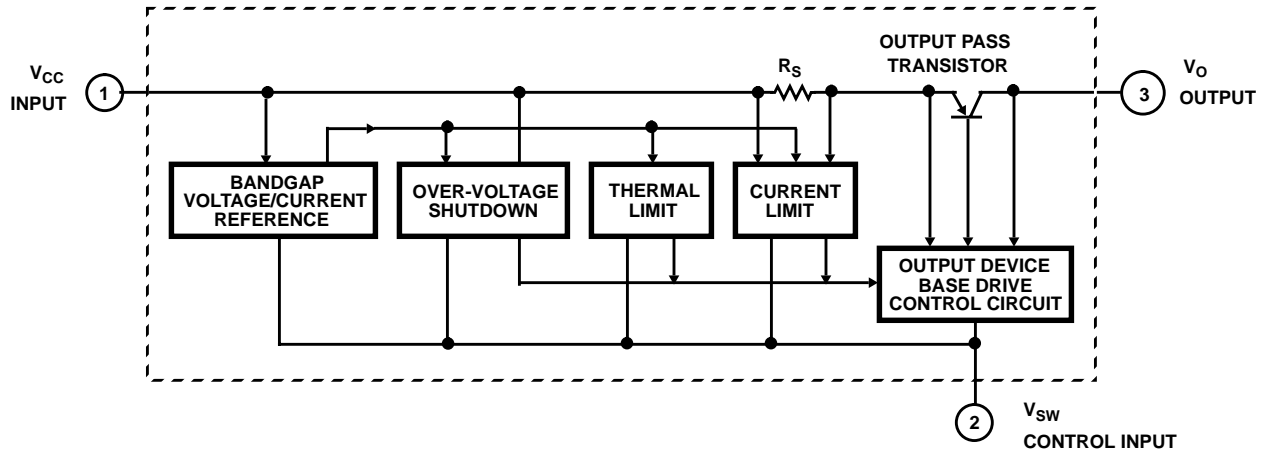


FIGURE 1. FUNCTIONAL BLOCK DIAGRAM OF CA3273

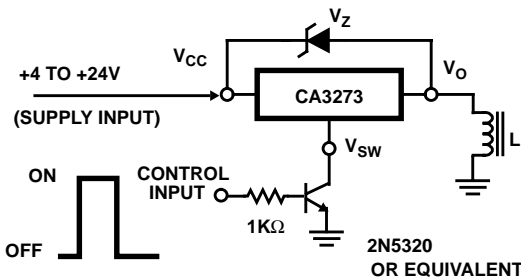


FIGURE 2. TYPICAL APPLICATION WITH ZENER DIODE FOR OVER-VOLTAGE PROTECTION WITH INDUCTIVE LOAD SWITCHING. V_z SHOULD BE LESS THAN 35V. WHEN CURRENT IS SWITCHED OFF IN THE OUTPUT LOAD (L), THE INDUCTIVE KICK PULSE GOES NEGATIVE. THE CLAMPED CLAMP LEVEL OF THE NEGATIVE GOING PULSE IS $V_{CC} - V_z$.

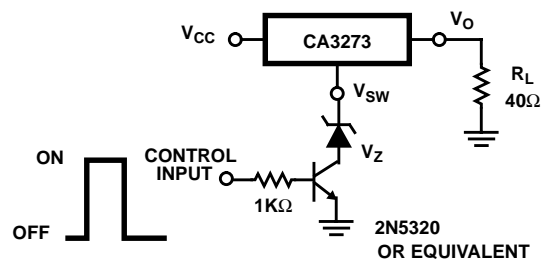


FIGURE 3. OPTIONAL RANGE SHIFTING OF THE V_{CC} INPUT VOLTAGE USING A ZENER DIODE TO OFFSET THE V_{sw} CONTROL PIN. (I.E., THE OVER-VOLTAGE SHUTDOWN THRESHOLD WILL BE INCREASED TO $V_{CC(THD)} + V_z$ AND THE MINIMUM V_{CC} OPERATING VOLTAGE IS $V_z + 4V$).

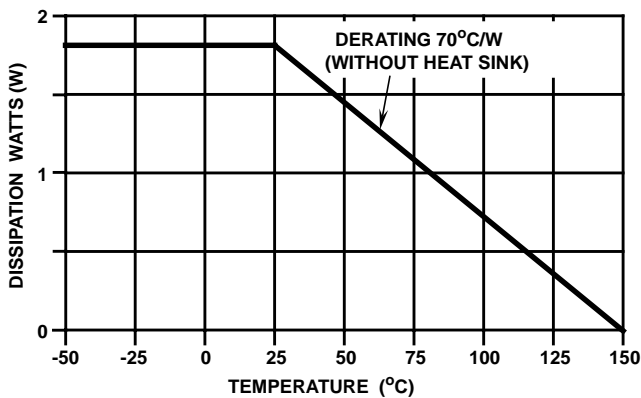


FIGURE 4. DISSIPATION DERATING CURVES

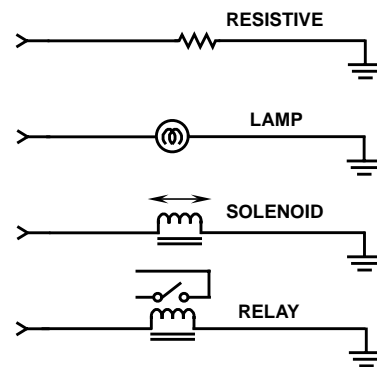


FIGURE 5. TYPICAL LOADS

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